

SID

Factory: Rot am See

Article:

658

ML6

Provided:

Stockburger, Olesja

Customer:

Date:

21.01.2016



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-070my 330x490mm	50200246	70	VS	1	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	295		2	
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		3	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		4	
C-RS-FR4-ML-0.30mm-070+070-TG150-HF	50200982	70	L2	5	A01
		300			
		70	L3		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	65		6	B00
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	170		7	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		8	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	65		9	
C-RS-FR4-ML-0.30mm-070+070-TG150-HF	50200982	70	L4	10	A02
		300			
		70	L5		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	295		11	
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		12	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		13	
A-RS Kupferfolie-070my 330x490mm	50200246	70	RS	14	

Thickness after Pressing

B00:

1890 µm

Tol+:

200 µm

Tol-:

200 µm

Dmax:

2090 µm

Dmin:

1690 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

2000 µm

Tol+:

200 µm

Tol-:

200 µm

Dmax:

2200 µm

Dmin:

1800 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

1910 µm

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